SDAS214E - DECEMBER 1982 - REVISED AUGUST 2002

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading

#### description/ordering information

These octal buffers/drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. When these devices are used with the 'ALS241, 'AS241A, 'ALS244, and 'AS244A devices, the circuit designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable (OE) inputs, and complementary OE and  $\overline{OE}$  inputs. These devices feature high fan-out and improved fan-in.

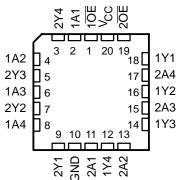
The -1 version of SN74ALS240A is identical to the standard version, except that the recommended maximum  $I_{OL}$  for the -1 version is 48 mA. There is no -1 version of the SN54ALS240A.

SN54ALS240A, SN54AS240A ... J OR W PACKAGE SN74ALS240A ... DB, DW, N, OR NS PACKAGE SN74AS240A ... DW OR N PACKAGE

#### (TOP VIEW) 20 VCC 1OE 19 20E 1A1 🛛 2 2Y4 🛛 3 18 1Y1 1A2 4 17 2A4 2Y3 🛛 5 16 1Y2 1A3 🛛 6 15 2A3 2Y2 🛛 14 1Y3 7 13 2A2 1A4 8 12 ] 1Y4 2Y1 **1**9 11 2A1 GND [ 10

# SN54ALS240A, SN54AS240A ... FK PACKAGE

(TOP VIEW)



#### **ORDERING INFORMATION**

	•			
т <sub>А</sub>	РАСКА	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			SN74ALS240AN	SN74ALS240AN
	PDIP – N	Tube	SN74ALS240A-1N	SN74ALS240A-1N
			SN74AS240AN	SN74AS240AN
		Tube	SN74ALS240ADW	41 00 40 4
	Tape and reel	SN74ALS240ADWR	ALS240A	
	SOIC - DW	Tube	SN74ALS240A-1DW	AL 6040A 4
0°C to 70°C	501C - DVV	Tape and reel	SN74ALS240A-1DWR	ALS240A-1
		Tube	SN74AS240ADW	450404
		Tape and reel	SN74AS240ADWR	AS240A
		Top a and real	SN74ALS240ANSR	ALS240A
	SOP – NS	Tape and reel	SN74ALS240A-1NSR	ALS240A-1
	SSOP – DB	Topo and real	SN74ALS240ADBR	G240A
	330F - DB	Tape and reel	SN74ALS240A-1DBR	G240A-1

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2002, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SDAS214E – DECEMBER 1982 – REVISED AUGUST 2002

#### description/ordering information (continued)

#### **ORDERING INFORMATION**

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	CDIP – J	Tube	SNJ54ALS240AJ	SNJ54ALS240AJ
	CDIP = J	Tube	SNJ54AS240AJ	SNJ54AS240AJ
		Tuba	SNJ54ALS240AW	SNJ54ALS240AW
–55°C to 125°C	CFP – W	Tube	SNJ54AS240AW	SNJ54AS240AW
		Tuba	SNJ54ALS240AFK	SNJ54ALS240AFK
	LCCC – FK	Tube	SNJ54AS240AFK	SNJ54AS240AFK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

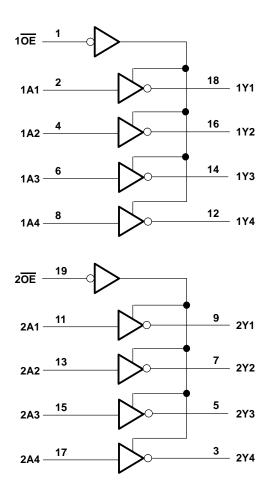
# FUNCTION TABLE

_		(each bl	itter)
ſ	INP	UTS	OUTPUT
Γ	OE	Α	Y
Γ	L	Н	L
	L	L	Н
	Н	Х	Z



SDAS214E - DECEMBER 1982 - REVISED AUGUST 2002

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub>	
Voltage applied to a disabled 3-state output	5.5 V
Package thermal impedance, $\theta_{JA}$ (see Note 1): DE	3 package
DV	V package 58°C/W
N	package 70°C/W
NS	S package 60°C/W
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.



SDAS214E - DECEMBER 1982 - REVISED AUGUST 2002

#### recommended operating conditions

			MIN	NOM	MAX	UNIT	
VCC	Supply voltage	pply voltage					
VIH	High-level input voltage		2			V	
		SN54ALS240A			0.7	V	
VIL	Low-level input voltage	SN74ALS240A, 'AS240A					
1		SN54ALS240A, SN54AS240A			-12	mA	
ЮН	High-level output current	SN74ALS240A, SN74AS240A			-15	IIIA	
		SN54ALS240A			12		
		CN7441 C2404			24		
IOL	Low-level output current	SN74ALS240A			48†	mA	
		SN54AS240A			48		
		SN74AS240A			64		
т.	Operating free oir temperature	SN54ALS240A, SN54AS240A	-55		125	°C	
TA	Operating free-air temperature	SN74ALS240A, SN74AS240A	0		70	Ĵ	

<sup>†</sup> Applies only to the -1 version and only if V<sub>CC</sub> is between 4.75 V and 5.25 V

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST OF	SNS	4ALS24	0A	SN7	4ALS24	0A	UNIT	
PARAMETER	IESI CO	ONDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = 4.5 V,	l <sub>l</sub> = –18 mA			-1.2			-1.2	V
	V <sub>CC</sub> = 4.5 V to 5.5 V,	I <sub>OH</sub> = -0.4 mA	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2	2		
Mari		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH	$V_{CC} = 4.5 V$	I <sub>OH</sub> = -12 mA	2						v
		I <sub>OH</sub> = -15 mA				2			
		I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	
VOL	$V_{CC} = 4.5 V$	I <sub>OL</sub> = 24 mA					0.35	0.5	V
		$I_{OL} = 48 \text{ mA}^{\dagger}$					0.35	0.5	
IOZH	$V_{CC} = 5.5 V,$	V <sub>O</sub> = 2.7 V			20			20	μA
IOZL	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.4 V			-20			-20	μA
lj	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 7 V			0.1			0.1	mA
ЦΗ	V <sub>CC</sub> = 5.5 V,	VI = 2.7 V			20			20	μA
١ <sub>L</sub>	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.1			-0.1	mA
۱ <sub>0</sub> §	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
		Outputs high		4	11		4	11	
ICC	V <sub>CC</sub> = 5.5 V	Outputs low		13	23		13	23	mA
		Outputs disabled		14	25		14	25	

<sup>†</sup> Applies only to the -1 version and only if V<sub>CC</sub> is between 4.75 V and 5.25 V <sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. § The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I<sub>OS</sub>.



SDAS214E - DECEMBER 1982 - REVISED AUGUST 2002

		TEAT A		SN	54AS24	0A	SN	74AS24	DA	
PA	ARAMETER	TEST C	TEST CONDITIONS			MAX	MIN	түр†	MAX	UNIT
VIK		V <sub>CC</sub> = 4.5 V,	lj = -18 mA			-1.2			-1.2	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2	2		
Val		VCC = 4.3 V 10 3.3 V	$I_{OH} = -3 \text{ mA}$	2.4	3.4		2.4	3.4		v
Vон			I <sub>OH</sub> = -12 mA	2.4						v
		$V_{CC} = 4.5 V$	I <sub>OH</sub> = -15 mA				2.4			
Vai			I <sub>OL</sub> = 48 mA		0.27	0.55				V
VOL		$V_{CC} = 4.5 V$	I <sub>OL</sub> = 64 mA					0.31	0.55	v
IOZH		$V_{CC} = 5.5 V,$	V <sub>O</sub> = 2.7 V			50			50	μA
IOZL		$V_{CC} = 5.5 V,$	V <sub>O</sub> = 0.4 V			-50			-50	μA
lj		$V_{CC} = 5.5 V,$	V <sub>I</sub> = 7 V			0.1			0.1	mA
IН		V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μA
	A inputs	V <sub>CC</sub> = 5.5 V,	V <sub>1</sub> = 0.4 V			-1			-1	mA
۱Ľ	OE inputs	$v_{CC} = 5.5 v,$	V] = 0.4 V			-0.5			-0.5	IIIA
10‡		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-50		-150	-50		-150	mA
			Outputs high		11	17		11	17	
ICC		V <sub>CC</sub> = 5.5 V	Outputs low		51	75		51	75	mA
			Outputs disabled		24	38		24	38	

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C. <sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I<sub>OS</sub>.

#### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C R R	V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T <sub>A</sub> = MIN to MAX§				
			SN54AL	.S240A	SN74AL	.S240A		
			MIN	MAX	MIN	MAX		
<sup>t</sup> PLH	A	v	2	22	2	9	ns	
<sup>t</sup> PHL	A	Ŷ	2	11	2	9	115	
<sup>t</sup> PZH	OE	v	4	34	5	13	20	
<sup>t</sup> PZL	ÛE	Ŷ	5	26	5	18	ns	
<sup>t</sup> PHZ	OE	v	1	15	2	10	ns	
<sup>t</sup> PLZ			3	24	3	12	115	

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SDAS214E - DECEMBER 1982 - REVISED AUGUST 2002

### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C R R	CC = 4.5 L = 50 pF 1 = 500 2 = 500 A = MIN t	2, 2,	ν,	UNIT
			SN54A	S240A	SN74A	S240A	
			MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	А	V	1	7	1	6.5	ns
<sup>t</sup> PHL	A	Ŷ	1.2	6.5	1.2	6.5	115
<sup>t</sup> PZH	OE	V	1	7	1	6.4	ns
<sup>t</sup> PZL	ÛE	ř	1.1	9.5	1.1	9	115
<sup>t</sup> PHZ	ŌĒ	v	1.2	5.5	1.2	5	
<sup>t</sup> PLZ			1.5	12.5	1.5	9.5	ns

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SDAS214E - DECEMBER 1982 - REVISED AUGUST 2002

#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES 7 V $R_{L} = R1 = R2$ Vcc **S**1 $\leq$ $R_L$ R1 From Output Test From Output Test From Output Test Point **Under Test Under Test** Under Test Point Point С $C_L$ 3 RL R2 $C_L$ (see Note A) (see Note A) (see Note A) LOAD CIRCUIT FOR LOAD CIRCUIT LOAD CIRCUIT **BI-STATE** FOR 3-STATE OUTPUTS **TOTEM-POLE OUTPUTS** FOR OPEN-COLLECTOR OUTPUTS 3.5 V 3.5 V Timing **High-Level** 1.3 V 1.3 V 1.3 V Input Pulse 0.3 V 0.3 V th t<sub>su</sub> 3.5 V 3.5 V Data Low-Level 1.3 V .3 V 1.3 V Input Pulse 0.3 V 0.3 V **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS** PULSE DURATIONS SETUP AND HOLD TIMES 3.5 V Output Control 1.3 V .3 V (low-level 0.3 V enabling) - 3.5 V <sup>t</sup>PZL 1.3 V 1.3 V Input <sup>t</sup>PLZ 0.3 V ≈3.5 V <sup>t</sup>PHL Waveform 1 **t**PLH .3 \ S1 Closed VOH In-Phase (see Note B) 1.3 V VOL 1.3 V Output VOL 0.3 V tphz 🔶 **t**PLH <sup>t</sup>PZH tPHL -Vон Waveform 2 Vон Out-of-Phase 1.3 V S1 Open 0.3 V 1.3 V 1.3 V Output (see Note B) VOL (see Note C) ≈0 V **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS** NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics:  $PRR \le 1$  MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

#### Figure 1. Load Circuits and Voltage Waveforms





www.ti.com

28-Aug-2010

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Peak Temp <sup>(3)</sup>	Samples (Requires Login)
5962-8859101SA	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	Purchase Samples
JM38510/38301B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	Purchase Samples
JM38510/38301BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	Purchase Samples
SN54ALS240AJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	Purchase Samples
SN74ALS240A-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240A-1DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240A-1DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240A-1N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS240A-1NE4	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS240A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240A-1NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240A-1NSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ADWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240AN	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS240ANE4	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples





www.ti.com

28-Aug-2010

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Peak Temp <sup>(3)</sup>	Samples (Requires Login)
SN74ALS240ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS240ANSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ADWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240AN	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74AS240ANE4	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74AS240ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS240ANSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SNJ54ALS240AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	Purchase Samples
SNJ54ALS240AJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	Purchase Samples
SNJ54ALS240AW	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	Purchase Samples
SNJ54AS240AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	Purchase Samples
SNJ54AS240AJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	Purchase Samples
SNJ54AS240AW	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	Purchase Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

# PACKAGE OPTION ADDENDUM



28-Aug-2010

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN54ALS240A, SN54AS240A, SN74ALS240A, SN74AS240A :

• Catalog: SN74ALS240A, SN74AS240A

• Military: SN54ALS240A, SN54AS240A

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

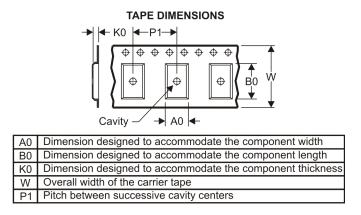
# PACKAGE MATERIALS INFORMATION

www.ti.com

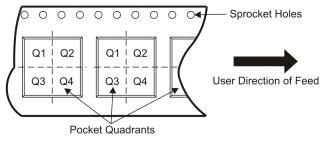
Texas Instruments

#### TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS240A-1NSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1
SN74ALS240ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1
SN74ALS240ANSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1
SN74AS240ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1
SN74AS240ANSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1

TEXAS INSTRUMENTS

www.ti.com

# PACKAGE MATERIALS INFORMATION

23-Jul-2010



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS240A-1NSR	SO	NS	20	2000	346.0	346.0	41.0
SN74ALS240ADWR	SOIC	DW	20	2000	346.0	346.0	41.0
SN74ALS240ANSR	SO	NS	20	2000	346.0	346.0	41.0
SN74AS240ADWR	SOIC	DW	20	2000	346.0	346.0	41.0
SN74AS240ANSR	SO	NS	20	2000	346.0	346.0	41.0

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20



MLCC006B - OCTOBER 1996

#### FK (S-CQCC-N\*\*)

#### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

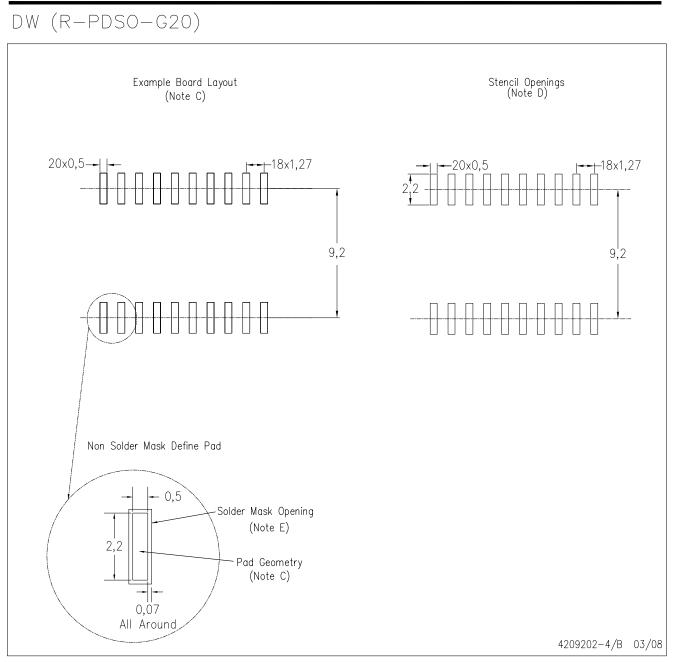
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



# LAND PATTERN



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DLP® Products	www.dlp.com	Communications and Telecom	www.ti.com/communications
DSP	dsp.ti.com	Computers and Peripherals	www.ti.com/computers
Clocks and Timers	www.ti.com/clocks	Consumer Electronics	www.ti.com/consumer-apps
Interface	interface.ti.com	Energy	www.ti.com/energy
Logic	logic.ti.com	Industrial	www.ti.com/industrial
Power Mgmt	power.ti.com	Medical	www.ti.com/medical
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Space, Avionics & Defense	www.ti.com/space-avionics-defense
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Video and Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless-apps

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2010, Texas Instruments Incorporated